



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Warren M. Farnworth  
Alan G. Wood  
Trung Tri Doan  
David R. Hembree

Group Art Unit: 2607

Examiner: Karlsen, E.

Serial No.: 08/120,628

Filing Date: September 13, 1993

Title: (as amended)  
BONDPAD ATTACHMENTS HAVING  
SELF-LIMITING PROPERTIES FOR  
PENETRATION OF SEMICONDUCTOR DIE

Attorney Docket No.: 91-62.7

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JUL - 8 1994  
GROUP 260  
51

AMENDMENT

Honorable Commissioner of Patents and Trademarks  
Box Amendment (Non-Fee)  
Washington D.C. 20231

Sir:

In response to the Office Action dated April 7, 1994 having a statutory period for response set to expire on July 7, 1994, please amend the captioned case as follows:

In the specification

In the Abstract, line 10, delete "and" first occurrence.

Page 16,

line 14, delete "circuit trace";  
line 15-16, delete "circuit trace".

Page 17,

lines 10-14, delete "copending U.S. Patent Application serial no. 7/898,617, filed 06/15/92, for PROCESS FOR FORMING RAISED SURFACE

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